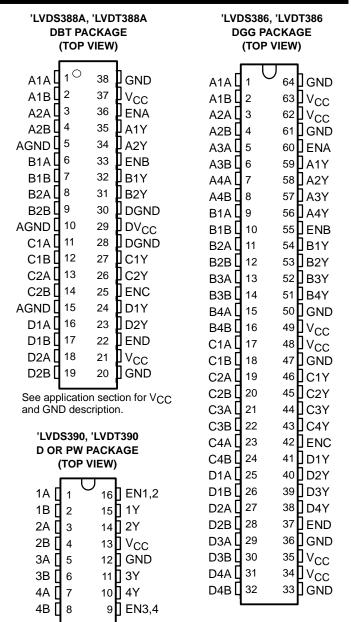
# SN65LVDS386/388A/390, SN65LVDT386/388A/390 SN75LVDS386/388A/390, SN75LVDT386/388A/390 HIGH-SPEED DIFFERENTIAL LINE RECEIVERS

SLLS394E - SEPTEMBER 1999 - REVISED SEPTEMBER 2002

- Four ('390), Eight ('388A), or Sixteen ('386)
  Line Receivers Meet or Exceed the
  Requirements of ANSI TIA/EIA-644
  Standard
- Integrated 110-Ω Line Termination Resistors on LVDT Products
- Designed for Signaling Rates<sup>†</sup> Up To 630 Mbps
- SN65 Version's Bus-Terminal ESD Exceeds 15 kV
- Operates From a Single 3.3-V Supply
- Typical Propagation Delay Time of 2.6 ns
- Output Skew 100 ps (Typ)
  Part-To-Part Skew Is Less Than 1 ns
- LVTTL Levels Are 5-V Tolerant
- Open-Circuit Fail Safe
- Flow-Through Pin Out
- Packaged in Thin Shrink Small-Outline Package With 20-mil Terminal Pitch

## description

This family of four, eight, or sixteen differential line receivers (with optional integrated termination) implements the electrical characteristics of low-voltage differential signaling (LVDS). This signaling technique lowers the output voltage levels of 5-V differential standard levels (such as EIA/TIA-422B) to reduce the power, increase the switching speeds, and allow operation with a 3-V supply rail. Any of the eight or sixteen differential receivers will provide a valid logical output state with a ±100 mV differential input voltage within the input common-mode voltage range. The input common-mode voltage range allows 1 V of around potential difference between two LVDS nodes. Additionally, the high-speed switching of LVDS signals almost always requires the use of a line impedance matching resistor at the receiving end of the cable or transmission media. The LVDT products eliminate this external resistor by integrating it with the receiver.





Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

† Signaling rate, 1/t, where t is the minimum unit interval and is expressed in the units bits/s (bits per second)



# SN65LVDS386/388A/390, SN65LVDT386/388A/390 SN75LVDS386/388A/390, SN75LVDT386/388A/390 HIGH-SPEED DIFFERENTIAL LINE RECEIVERS

SLLS394E - SEPTEMBER 1999 - REVISED SEPTEMBER 2002

## description (continued)

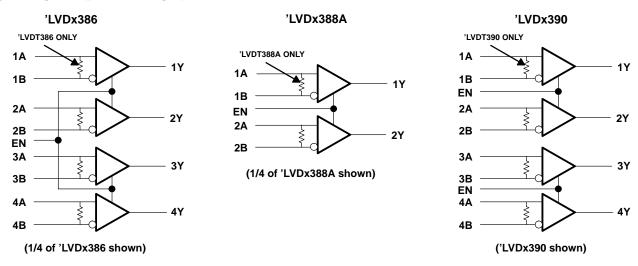
The intended application of this device and signaling technique is for point-to-point baseband data transmission over controlled impedance media of approximately  $100\,\Omega$ . The transmission media may be printed-circuit board traces, backplanes, or cables. The large number of receivers integrated into the same substrate along with the low pulse skew of balanced signaling, allows extremely precise timing alignment of clock and data for synchronous parallel data transfers. When used with its companion, 8- or 16-channel driver, the SN65LVDS389 or SN65LVDS387, over 300 million data transfers per second in single-edge clocked systems are possible with very little power. (Note: The ultimate rate and distance of data transfer is dependent upon the attenuation characteristics of the media, the noise coupling to the environment, and other system characteristics.)

#### **AVAILABLE OPTIONS**

TEMPERATURE NUMBER OF THE TOTAL					
PART NUMBER	RANGE	RECEIVERS	BUS-PIN ESD	SYMBOLIZATION	
SN65LVDS386DGG	–40°C to 85°C	16	15 kV	LVDS386	
SN65LVDT386DGG	–40°C to 85°C	16	15 kV	LVDT386	
SN75LVDS386DGG	0°C to 70°C	16	4 kV	75LVDS386	
SN75LVDT386DGG	0°C to 70°C	16	4 kV	75LVDT386	
SN65LVDS388ADBT	–40°C to 85°C	8	15 kV	LVDS388A	
SN65LVDT388ADBT	–40°C to 85°C	8	15 kV	LVDT388A	
SN75LVDS388ADBT	0°C to 70°C	8	4 kV	75LVDS388A	
SN75LVDT388ADBT	0°C to 70°C	8	4 kV	75LVDT388A	
SN65LVDS390D	–40°C to 85°C	4	15 kV	LVDS390	
SN65LVDS390PW	–40°C to 85°C	4	15 kV	LVDS390	
SN65LVDT390D	–40°C to 85°C	4	15 kV	LVDT390	
SN65LVDT390PW	–40°C to 85°C	4	15 kV	LVDT390	
SN75LVDS390D	0°C to 70°C	4	4 kV	75LVDS390	
SN75LVDS390PW	0°C to 70°C	4	4 kV	DS390	
SN75LVDT390D	0°C to 70°C	4	4 kV	75LVDT390	
SN75LVDT390PW	0°C to 70°C	4	4 kV	DG390	



## logic diagram (positive logic)

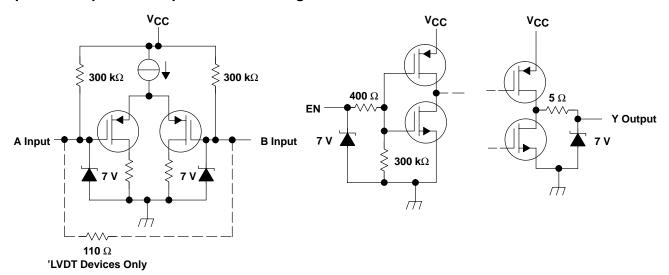


Function Table SNx5LVD386/388A/390 and SNx5LVDT386/388A/390

DIFFERENTIAL INPUT	ENABLES	OUTPUT
A-B	EN	Υ
V <sub>ID</sub> ≥ 100 mV	Н	Н
-100 mV < V <sub>ID</sub> ≤ 100 mV	Н	?
$V_{ID} \le -100 \text{ mV}$	Н	L
Х	L	Z
Open	Н	Н

H = high level, L = low level, X = irrelevant, Z = high impedance (off), ? = indeterminate

## equivalent input and output schematic diagrams



# SN65LVDS386/388A/390, SN65LVDT386/388A/390 SN75LVDS386/388A/390, SN75LVDT386/388A/390 HIGH-SPEED DIFFERENTIAL LINE RECEIVERS

SLLS394E - SEPTEMBER 1999 - REVISED SEPTEMBER 2002

## absolute maximum ratings over operating free-air temperature (unless otherwise noted)†

Supply voltage rai	nge, V <sub>CC</sub> (see Note 1)	0.5 V to 4 V
Voltage range:	Enables or Y	0.5 V to 6 V
	A or B	0.5 V to 4 V
Electrostatic disch	narge: (see Note 2)	
	SN65' (A, B, and GND)	Class 3, A:15 kV, B: 700 V
	SN75' (A, B, and GND)	Class 2, A:4 kV, B: 400 V
Continuous power	r dissipation	See Dissipation Rating Table
Storage temperati	ure range	65°C to 150°C
Lead temperature	1,6 mm (1/16 in) from case for 10 seconds .	260°C

<sup>†</sup> Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTES: 1. All voltage values, except differential I/O bus voltages, are with respect to network ground terminal.

#### **DISSIPATION RATING TABLE**

PACKAGE	T <sub>A</sub> ≤ 25°C	DERATING FACTOR <sup>‡</sup> ABOVE T <sub>A</sub> = 25°C	T <sub>A</sub> = 70°C POWER RATING	T <sub>A</sub> = 85°C POWER RATING
D	950 mW	7.6 mW/°C	608 mW	494 mW
DBT	1071 mW	8.5 mW/°C	688 mW	556 mW
DGG	2094 mW	16.7 mW/°C	1342 mW	1089 mW
PW	774 mW	6.2 mW/°C	496 mW	402 mW

<sup>‡</sup> This is the inverse of the junction-to-ambient thermal resistance when board-mounted (low-k) and with no air flow.

### recommended operating conditions

	MIN	NOM	MAX	UNIT	
Supply voltage, V <sub>CC</sub>		3	3.3	3.6	V
High-level input voltage, V <sub>IH</sub>		2			V
Low-level input voltage, V <sub>IL</sub>				0.8	V
Magnitude of differential input voltage,  V <sub>ID</sub>		0.1		0.6	V
Common-mode input voltage, V <sub>IC</sub> (see Figure 4)		$\frac{ V_{\text{ID}} }{2}$	2.	$4 - \frac{ V_{\text{ID}} }{2}$	V
			\	√ <sub>CC</sub> – 0.8	
SN75'		0		70	°C
Operating free-air temperature, T <sub>A</sub>	SN65'	-40		85	°C

<sup>2.</sup> Tested in accordance with MIL-STD-883C Method 3015.7.

## electrical characteristics over recommended operating conditions (unless otherwise noted)

PARAMETER		TEST CONDITIONS	MIN	TYP <sup>†</sup>	MAX	UNIT	
V <sub>IT+</sub>	Positive-going differential input voltage three	ositive-going differential input voltage threshold				100	mV
$V_{IT-}$	V <sub>IT</sub> — Negative-going differential input voltage threshold		See Figure 1 and Table 1	-100			mV
Vон	High-level output voltage		I <sub>OH</sub> = -8 mA	2.4	3		V
VOL	Low-level output voltage		I <sub>OL</sub> = 8 mA		0.2	0.4	V
		'LVDx386			50	70	
		'LVDx388A	Enabled, No load		22	40	
	Cumply augrent	'LVDx390	]		8	18	A
Icc	Supply current	'LVDx386				3	mA
		'LVDx388A	Disabled		-	3	
		'LVDx390	1			1.5	
	Input current (A or B inputs)		V <sub>I</sub> = 0 V		-13	-20	μΑ
lı Ir		'LVDS	V <sub>I</sub> = 2.4 V	-1.2	-3		
		LVDT	V <sub>I</sub> = 0 V, other input open			-40	
		LVDI	V <sub>I</sub> = 2.4 V, other input open	-2.4			
I <sub>ID</sub>	Differential input current  I <sub>IA</sub> - I <sub>IB</sub>	'LVDS	V <sub>IA</sub> = 0 V, V <sub>IB</sub> = 0.1 V, V <sub>IA</sub> = 2.4 V, V <sub>IB</sub> = 2.3 V			±2	μΑ
I <sub>ID</sub>	Differential input current (I <sub>IA</sub> – I <sub>IB</sub> )	'LVDT	V <sub>IA</sub> = 0.2 V, V <sub>IB</sub> = 0 V, V <sub>IA</sub> = 2.4 V, V <sub>IB</sub> = 2.2 V	1.5		2.2	mA
l <sub>l</sub> (OFF)	Power-off Input current (A or B inputs)	'LVDS	$V_{CC} = 0 \text{ V}, \qquad V_{I} = 2.4 \text{ V}$		12	±20	μΑ
I <sub>I</sub> (OFF)	Power-off Input current (A or B inputs)	'LVDT	$V_{CC} = 0 \text{ V}, \qquad V_{I} = 2.4 \text{ V}$			±40	μΑ
ΊΗ	High-level input current (enables)		V <sub>IH</sub> = 2 V			10	μΑ
I <sub>IL</sub>	Low-level input current (enables)		V <sub>IL</sub> = 0.8 V			10	μΑ
	High incomedance autout account	,	V <sub>O</sub> = 0 V		-	±1	
	High-impedance output current		V <sub>O</sub> = 3.6 V			10	μΑ
C <sub>IN</sub>	Input capacitance, A or B input to GND		V <sub>ID</sub> = 0.4 sin 2.5E09 t V		5		pF
Z <sub>(t)</sub>	Termination impedance		V <sub>ID</sub> = 0.4 sin 2.5E09 t V	88		132	Ω

<sup>&</sup>lt;sup>†</sup> All typical values are at 25°C and with a 3.3-V supply.

## switching characteristics over recommended operating conditions (unless otherwise noted)

	PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT
tPLH	Propagation delay time, low-to-high-level output		1	2.6	4	ns
tPHL	Propagation delay time, high-to-low-level output	1	1	2.5	4	ns
t <sub>r</sub>	Output signal rise time		500	800	1200	ps
tf	Output signal fall time	See Figure 2	500	800	1200	ps
t <sub>sk(p)</sub> Pulse skew ( tpHL - tpLH )				150	600	ps
t <sub>sk(o)</sub> Output skew <sup>‡</sup>				100	400	ps
t <sub>sk(pp)</sub> Part-to-part skew§					1	ns
t <sub>PZH</sub> Propagation delay time, high-impedance-to-high-level output				7	15	ns
t <sub>PZL</sub>	Propagation delay time, high-impedance-to-low-level output	Con Figure 2		7	15	ns
tPHZ	Propagation delay time, high-level-to-high-impedance output	See Figure 3		7	15	ns
tPLZ	Propagation delay time, low-level-to-high-impedance output	1		7	15	ns

<sup>†</sup> All typical values are at 25°C and with a 3.3-V supply.

<sup>‡</sup> t<sub>sk(0)</sub> is the magnitude of the time difference between the tp<sub>LH</sub> or tp<sub>HL</sub> of all drivers of a single device with all of their inputs connected together. § t<sub>sk(pp)</sub> is the magnitude of the difference in propagation delay times between any specified terminals of any two devices characterized in this data sheet when both devices operate with the same supply voltage, at the same temperature, and have the same test circuits.



## PARAMETER MEASUREMENT INFORMATION

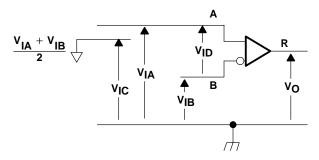


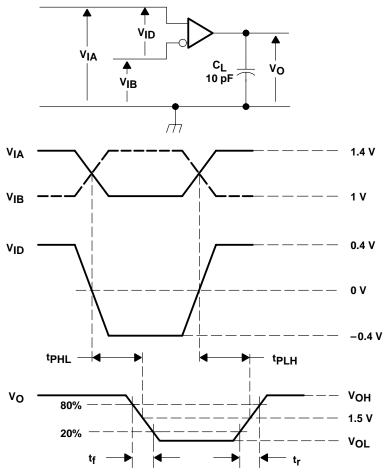
Figure 1. Voltage Definitions

Table 1. Receiver Minimum and Maximum Input Threshold Test Voltages

APPLIED VO	OLTAGES	RESULTING DIFFERENTIAL INPUT VOLTAGE	RESULTING COMMON- MODE INPUT VOLTAGE
VIA	V <sub>IB</sub>	V <sub>ID</sub>	VIC
1.25 V	1.15 V	100 mV	1.2 V
1.15 V	1.25 V	–100 mV	1.2 V
2.4 V	2.3 V	100 mV	2.35 V
2.3 V	2.4 V	–100 mV	2.35 V
0.1 V	0 V	100 mV	0.05 V
0 V	0.1 V	–100 mV	0.05 V
1.5 V	0.9 V	600 mV	1.2 V
0.9 V	1.5 V	−600 mV	1.2 V
2.4 V	1.8 V	600 mV	2.1 V
1.8 V	2.4 V	−600 mV	2.1 V
0.6 V	0 V	600 mV	0.3 V
0 V	0.6 V	−600 mV	0.3 V



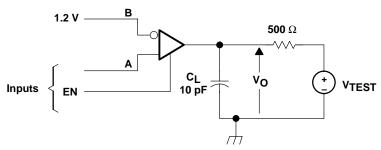
## PARAMETER MEASUREMENT INFORMATION



NOTE: All input pulses are supplied by a generator having the following characteristics:  $t_r$  or  $t_f \le 1$  ns, pulse repetition rate (PRR) = 50 Mpps, pulse width =  $10 \pm 0.2$  ns.  $C_L$  includes instrumentation and fixture capacitance within 0,06 m of the D.U.T.

Figure 2. Timing Test Circuit and Wave Forms

#### PARAMETER MEASUREMENT INFORMATION



NOTE A: All input pulses are supplied by a generator having the following characteristics:  $t_{\Gamma}$  or  $t_{\Gamma} \le 1$  ns, pulse repetition rate (PRR) = 0.5 Mpps, pulse width =  $500 \pm 10$  ns. C<sub>L</sub> includes instrumentation and fixture capacitance within 0,06 m of the D.U.T.

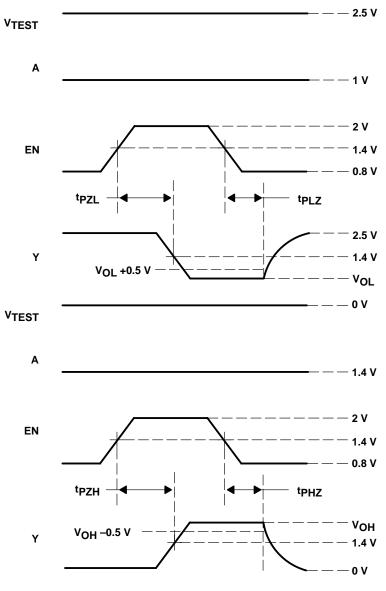
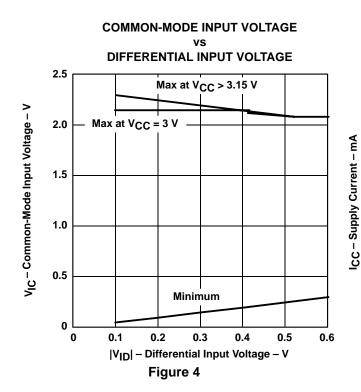
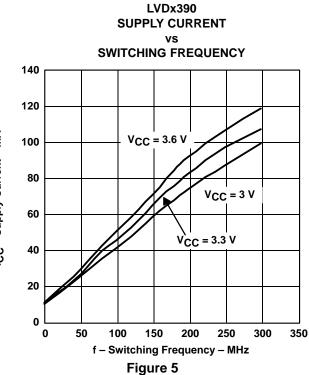


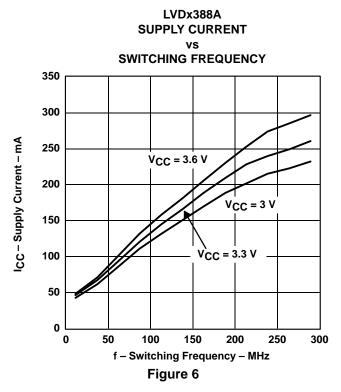
Figure 3. Enable/Disable Time Test Circuit and Wave Forms

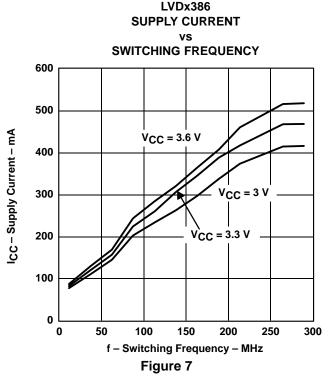


#### **TYPICAL CHARACTERISTICS**

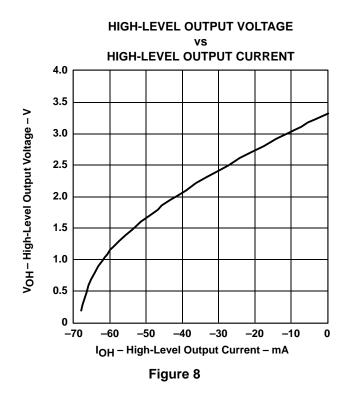


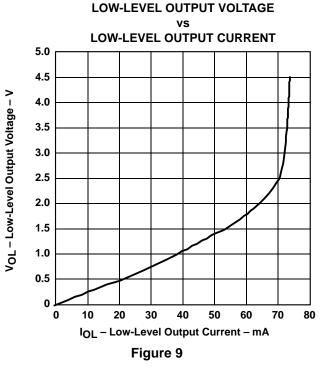




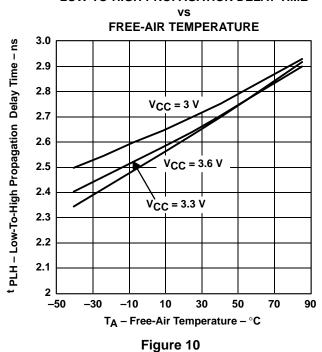


#### TYPICAL CHARACTERISTICS

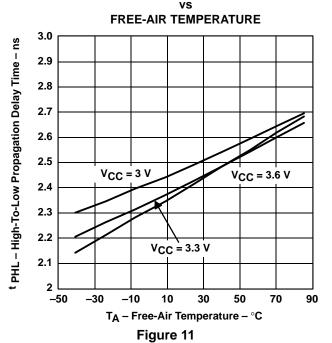




#### **LOW-TO-HIGH PROPAGATION DELAY TIME**



# HIGH-TO-LOW PROPAGATION DELAY TIME



#### **APPLICATION INFORMATION**

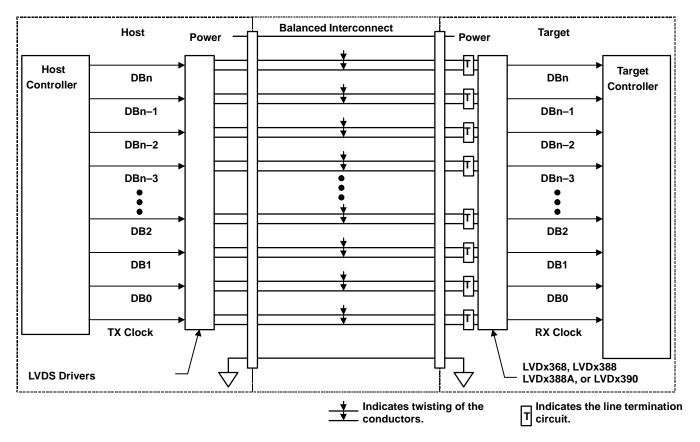


Figure 12. Typical Application Schematic

#### **APPLICATION INFORMATION**

### analog and digital grounds/power supplies

Although it is not necessary to separate out the analog/digital supplies and grounds on the SN65LVDS/T388A and SN75LVDS/T388A, the pinout provides the user that option. To help minimize or perhaps eliminate switching noise being coupled between the two supplies, the user could lay out separate supply and ground planes for the designated pinout.

Most applications will probably have all grounds connected together and all power supplies connected together. This configuration was used while characterizing and setting the data sheet parameters.

#### fail safe

One of the most common problems with differential signaling applications is how the system responds when no differential voltage is present on the signal pair. The LVDS receiver is like most differential line receivers, in that its output logic state can be indeterminate when the differential input voltage is between -100 mV and 100 mV and within its recommended input common-mode voltage range. TI's LVDS receiver is different in how it handles the open-input circuit situation, however.

Open-circuit means that there is little or no input current to the receiver from the data line itself. This could be when the driver is in a high-impedance state or the cable is disconnected. When this occurs, the LVDS receiver will pull each line of the signal pair to near  $V_{CC}$  through 300-k $\Omega$  resistors as shown in Figure 13. The fail-safe feature uses an AND gate with input voltage thresholds at about 2.3 V to detect this condition and force the output to a high-level regardless of the differential input voltage.

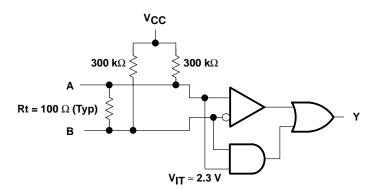


Figure 13. Open-Circuit Fail Safe of the LVDS Receiver

It is only under these conditions that the output of the receiver will be valid with less than a 100-mV differential input voltage magnitude. The presence of the termination resistor, Rt, does not affect the fail-safe function as long as it is connected as shown in the figure. Other termination circuits may allow a dc current to ground that could defeat the pullup currents from the receiver and the fail-safe feature.

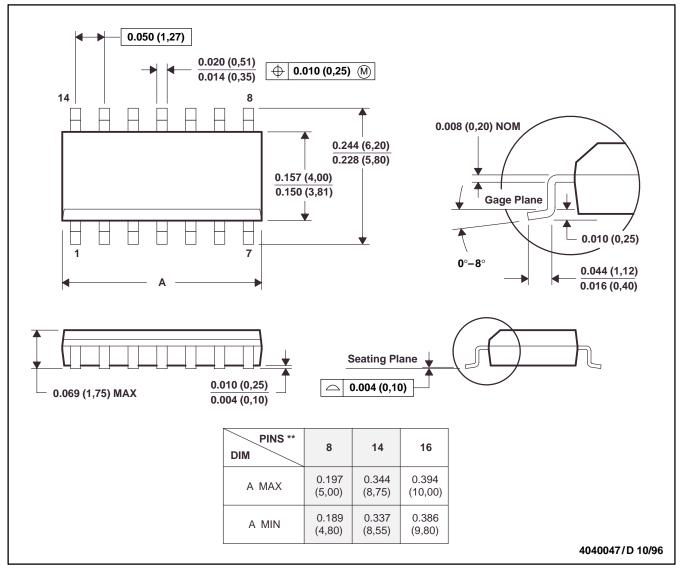


#### **MECHANICAL DATA**

## D (R-PDSO-G\*\*)

#### 14 PINS SHOWN

### PLASTIC SMALL-OUTLINE PACKAGE



NOTES: A. All linear dimensions are in inches (millimeters).

B. This drawing is subject to change without notice.

C. Body dimensions do not include mold flash or protrusion, not to exceed 0.006 (0,15).

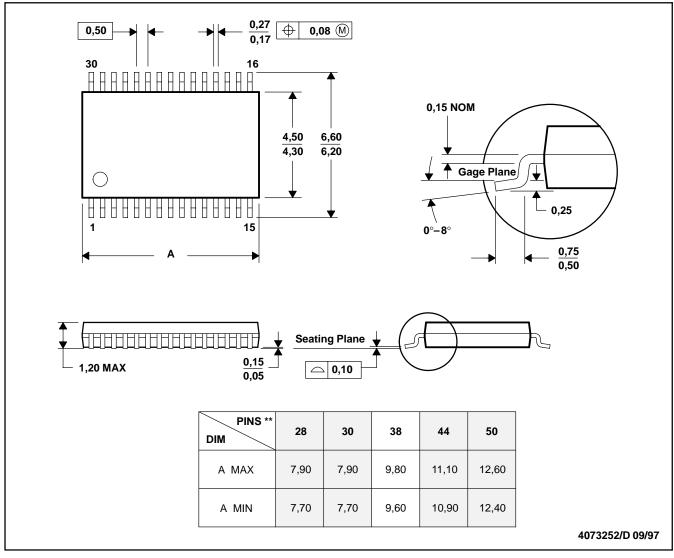
D. Falls within JEDEC MS-012

#### **MECHANICAL DATA**

## DBT (R-PDSO-G\*\*)

#### **30 PINS SHOWN**

### PLASTIC SMALL-OUTLINE PACKAGE



NOTES: A. All linear dimensions are in millimeters.

B. This drawing is subject to change without notice.

C. Body dimensions do not include mold flash or protrusion.

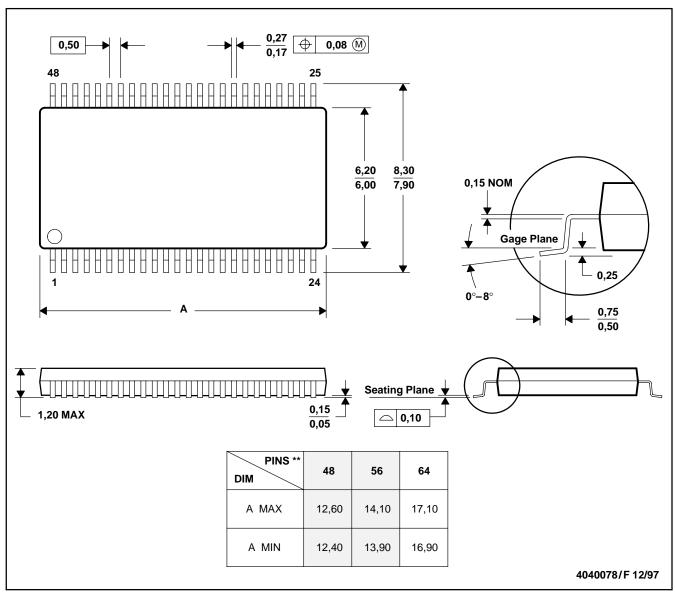
D. Falls within JEDEC MO-153

#### **MECHANICAL DATA**

## DGG (R-PDSO-G\*\*)

# 48 PINS SHOWN

### PLASTIC SMALL-OUTLINE PACKAGE



NOTES: A. All linear dimensions are in millimeters.

B. This drawing is subject to change without notice.

C. Body dimensions do not include mold protrusion not to exceed 0,15.

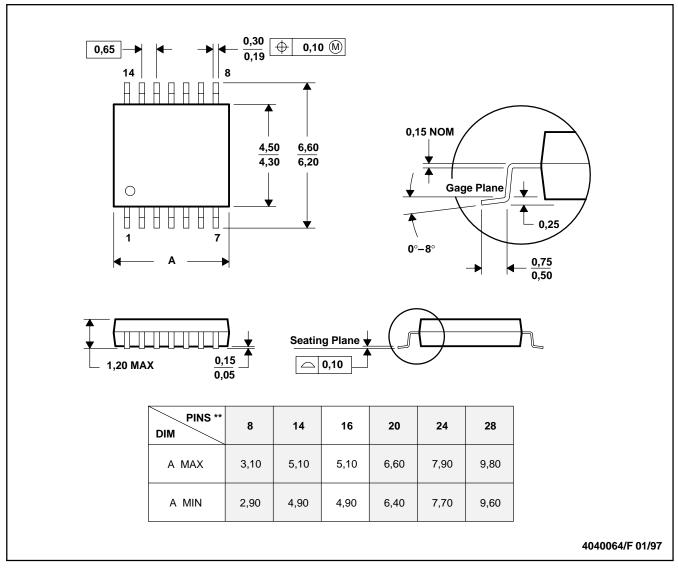
D. Falls within JEDEC MO-153

## **MECHANICAL DATA**

## PW (R-PDSO-G\*\*)

#### **14 PINS SHOWN**

### PLASTIC SMALL-OUTLINE PACKAGE



NOTES: A. All linear dimensions are in millimeters.

B. This drawing is subject to change without notice.

C. Body dimensions do not include mold flash or protrusion not to exceed 0,15.

D. Falls within JEDEC MO-153

#### **IMPORTANT NOTICE**

Texas Instruments Incorporated and its subsidiaries (TI) reserve the right to make corrections, modifications, enhancements, improvements, and other changes to its products and services at any time and to discontinue any product or service without notice. Customers should obtain the latest relevant information before placing orders and should verify that such information is current and complete. All products are sold subject to TI's terms and conditions of sale supplied at the time of order acknowledgment.

TI warrants performance of its hardware products to the specifications applicable at the time of sale in accordance with TI's standard warranty. Testing and other quality control techniques are used to the extent TI deems necessary to support this warranty. Except where mandated by government requirements, testing of all parameters of each product is not necessarily performed.

TI assumes no liability for applications assistance or customer product design. Customers are responsible for their products and applications using TI components. To minimize the risks associated with customer products and applications, customers should provide adequate design and operating safeguards.

TI does not warrant or represent that any license, either express or implied, is granted under any TI patent right, copyright, mask work right, or other TI intellectual property right relating to any combination, machine, or process in which TI products or services are used. Information published by TI regarding third—party products or services does not constitute a license from TI to use such products or services or a warranty or endorsement thereof. Use of such information may require a license from a third party under the patents or other intellectual property of the third party, or a license from TI under the patents or other intellectual property of TI.

Reproduction of information in TI data books or data sheets is permissible only if reproduction is without alteration and is accompanied by all associated warranties, conditions, limitations, and notices. Reproduction of this information with alteration is an unfair and deceptive business practice. TI is not responsible or liable for such altered documentation.

Resale of TI products or services with statements different from or beyond the parameters stated by TI for that product or service voids all express and any implied warranties for the associated TI product or service and is an unfair and deceptive business practice. TI is not responsible or liable for any such statements.

Mailing Address:

Texas Instruments Post Office Box 655303 Dallas, Texas 75265

Copyright © 2002, Texas Instruments Incorporated